LNJ426W83RA1

Surface Mounting Chip LED

UTSS Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	40	mW	
Forward current	I_{F}	15	mA	
Pulse forward current *	I_{FP}	40	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

■ Lighting Color

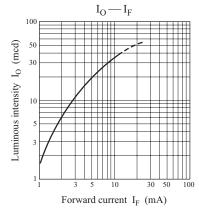
• Amber

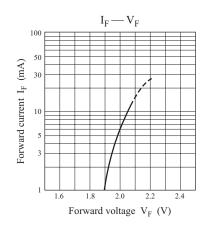
■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

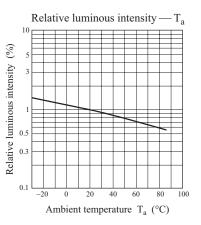
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *1	I _O	$I_F = 10 \text{ mA}$	12.0	35.0	102.0	mcd
Reverse current	I_R	$V_R = 4 V$			100	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$		2.05	2.5	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$		595		nm
Dominant emission wavelength *2	λ_{d}	$I_F = 10 \text{ mA}$	585	589	596	nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$		15		nm

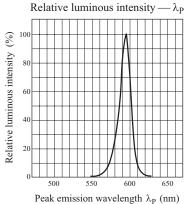
Note) *1: Measurement tolerance: $\pm 20\%$

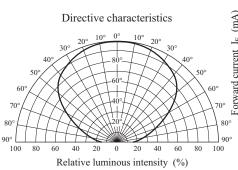


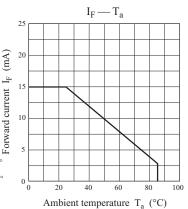






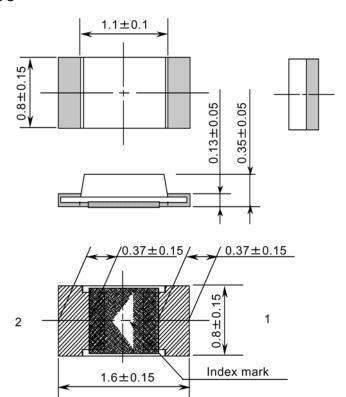






■ Package (Unit: mm)

KLTFTN2K2600



- Pin name
 - 1: Anode
 - 2: Cathode

2 SHD00716BEK

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